

General Description

The MAX6613 is a low-power analog precision analog output temperature sensor in a tiny 5-pin SC70 package. The MAX6613 operates over a supply voltage range of 1.8V to 5.5V, with a typical current consumption of only 7.5µA. It is particularly well suited for portable applications where minimizing battery cost and maximizing useful battery life are crucial.

The MAX6613 provides an analog voltage output proportional to temperature. Accuracy is ±1.3°C (max) over a range of $T_A = 0^{\circ}C$ to $+50^{\circ}C$ and $\pm 2.0^{\circ}C$ (max) from T_A = -20°C to +80°C. Self-heating effects are negligible due to the low current consumption of the part.

Unlike many analog temperature sensors, the MAX6613 is stable with any capacitive load from 0pF to 1000pF, providing broad flexibility in board-level design.

The operating temperature range varies with the voltage supply. The MAX6613 can be used over a range of -55°C to +130°C with a supply voltage of 2.5V to 5.5V. For applications with a supply voltage of 1.8V, the MAX6613 can be used over a temperature range of +25°C to +130°C.

Applications

Disk Drives Cellular Phones **GPS** Equipment **Printers** Medical Instruments Fax Machines

Battery Management HVAC

Appliances

Features

- ♦ Supply Voltage from 1.8V to 5.5V
- ♦ 1.3°C Accuracy
- ♦ Low Supply Consumption, 7.5µA (typ)
- ◆ Temperature Range -55°C to +130°C
- ♦ SC70 Package
- ♦ Pin Compatible to LM20

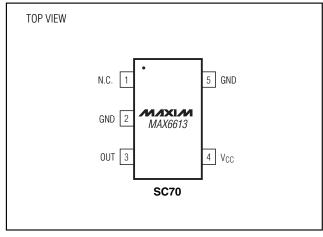
Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK	
MAX6613MXK-T	-55°C to +130°C	5 SC70-5	ADJ	

Typical Application Circuit

Vcc Vcc MICROCONTROLLER Vrr VOUT ADC IN MIXKIM 0.1µF MAX6613 GND 100pF GND GND

Pin Configuration



MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

(All Voltages Referenced to GND, Unle	ess Otherwise Noted.)
V _{CC} to GND	0.3V to +6V
All Other Pins to GND	0.3V to (V _{CC} + 0.3V)
OUT Short to GND	Continuous
Output Current	1mA to +50mA
ESD Protection (Human Body Model)	2000V

5-Pin SC70 (derate 3.1mW/°C above +70°C)246.9mW Operating Temperature Range55°C to +130°C
I I' T I
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (soldering 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{CC} = 1.8V to 5.5V, T_A = -55°C to +130°C. Typical values are at T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Temperature-to-Voltage Error (Notes 2, 3)		$V_{CC} = 2.7V$, $T_A = 0^{\circ}C$ to $+50^{\circ}C$	-1.3		+1.3	°C
		$V_{CC} = 2.7V$, $T_A = -20^{\circ}C$ to $+85^{\circ}C$	-2		+2	
		$V_{CC} = 2.7V$, $T_A = -55^{\circ}C$ to $+100^{\circ}C$	-2.4		+2.4	
		$V_{CC} = 2.7V$, $T_A = +100^{\circ}C$ to $+125^{\circ}C$	-2.8		+2.8	
		$V_{CC} = 2.7V$, $T_A = +125^{\circ}C$ to $+130^{\circ}C$	-3.1		+3.1	
Output Voltage		$T_A = 0$ °C		1.8455		V
Nonlinearity		$T_A = -55^{\circ}C \text{ to } +100^{\circ}C$		±0.4		%
Sensor Gain (Temperature Sensitivity or Average Slope)		$T_A = -20^{\circ}C \text{ to } +100^{\circ}C \text{ (Note 3)}$	-10.98	-11.23	-11.47	mV/°C
Maximum Output Impadance		$0 < I_L < 16\mu A$, $T_A = -55^{\circ}C$ to $+125^{\circ}C$			160	Ω
Maximum Output Impedance		0 < I _L < 16μA, T _A = +125°C to +130°C			300	
Load Degulation		$0 < I_L < 16\mu A$, $T_A = -55^{\circ}C$ to $+125^{\circ}C$			-2.5	mV
Load Regulation		$0 < I_L < 16\mu A$, $T_A = 125^{\circ}C$ to $130^{\circ}C$			-4.8	IIIV
		$T_A = -20^{\circ}\text{C to} + 130^{\circ}\text{C}, V_{CC} \le 5.5\text{V}$		1	3.3	mV/V
Supply Sensitivity (Note 3)		$T_A = -55$ °C to -20°C, $V_{CC} \le 4.5$ V		1	4.7	
		$T_A = -55$ °C to -20°C, $V_{CC} \le 5.5$ V		1		
Quiescent Current	IQ	No load		7.5	13	μΑ
Capacitive Load		No sustained oscillations for capacitive loads in this range (Note 4)	0		1000	рF
Long-Term Stability		T _A = room temperature for 1000hr (Note 4)		0.1		°C
Temperature Coefficient of Supply Current				15		nA/°C
Power-Down Supply Current		V _{CC} < 0.8V		0.1		μΑ

Note 1: All parameters tested at room temperature. Values through temperature limits are guaranteed by design.

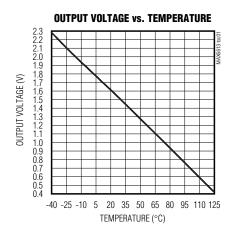
Note 2: $V_{OUT} = -0.0000022 \times T^2 - 0.0115 \times T + 1.8639$ (T = temperature in degrees Celsius).

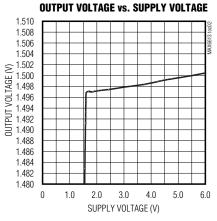
Note 3: Guaranteed by design to 3 sigma.

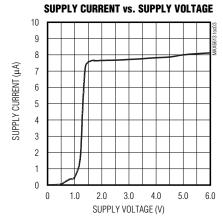
Note 4: Guaranteed by design.

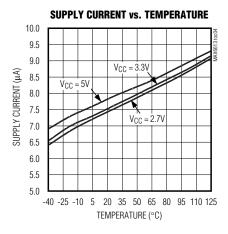
Typical Operating Characteristics

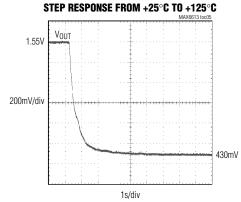
 $(R_L = \infty \Omega, T_A = +30^{\circ}C, \text{ unless otherwise noted.})$











Pin Description

PIN	NAME	FUNCTION				
1	N.C.	No Connection. Must be connected to ground or left floating.				
2	GND	Ground. Should be connected to pin 5. May be left floating, if desired.				
3	OUT	Voltage Output				
4	Vcc	Supply Voltage. Bypass to GND with a 0.1µF capacitor.				
5	GND	Ground				

Table 1. Linear and Quadratic Output Equation

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Temperature Error Based on: OUT = 1.8639 - 0.0115 × Temp (Note 4)		V _{CC} = 2.7V, T _A = -55°C	2.06		6.57	
		V _{CC} = 2.7V, T _A = -40°C	1.19		5.73	
		V _{CC} = 2.7V, T _A = -20°C	0.55		4.36	
		$V_{CC} = 2.7V, T_A = 0^{\circ}C$	0.35		2.85	
		$V_{CC} = 2.7V, T_A = +20^{\circ}C$	-0.37		+2.15	°C
		$V_{CC} = 2.7V, T_A = +40^{\circ}C$	-1.32		+1.61	
		$V_{CC} = 2.7V, T_A = +60^{\circ}C$	-2.02		+1.92	
		V _{CC} = 2.7V, T _A = +85°C	-2.32		+1.66	
		$V_{CC} = 2.7V, T_A = +100^{\circ}C$	-2.78		+2.01	
		$V_{CC} = 2.7V, T_A = +125^{\circ}C$	-3.11		+2.54	
		$V_{CC} = 2.7V, T_A = +130^{\circ}C$	-3.37		+2.90	
		V _{CC} = 2.7V, T _A = -55°C	1.08		5.76	°C
		$V_{CC} = 2.7V, T_A = -40^{\circ}C$	0.67		5.33	
		$V_{CC} = 2.7V, T_A = -20^{\circ}C$	0.42		4.28	
Temperature Error Based on: OUT = 1.8639 - 0.0115 × Temp - 0.00000388 × Temp2 (Note 4)		$V_{CC} = 2.7V, T_A = 0^{\circ}C$	0.35		2.85	
		V _{CC} = 2.7V, T _A = +20°C	-0.49		+1.99	
		$V_{CC} = 2.7V, T_A = +30^{\circ}C$	-0.95		+1.53	
		$V_{CC} = 2.7V, T_A = +40^{\circ}C$	-1.81		+1.05	
		V _{CC} = 2.7V, T _A = +50°C	-1.93		+0.54	
		V _{CC} = 2.7V, T _A = +60°C	-3.11		+0.67	
		V _{CC} = 2.7V, T _A = +85°C	-4.51		-0.74	
		V _{CC} = 2.7V, T _A = +100°C	-5.77		-1.28	
		V _{CC} = 2.7V, T _A = +125°C	-7.74		-2.52	
		V _{CC} = 2.7V, T _A = +130°C	-8.35		-2.58	

Detailed Description

The MAX6613 analog output temperature sensor's output voltage is a discrete function of its die temperature. The maximum supply current is 13 μ A, and the supply voltage range is from 2.5V to 5.5V for the -55°C to +130°C temperature range, or 1.8V to 5.5V for the +25°C to +130°C temperature range.

Transfer Function

The temperature-to-voltage transfer function is approximately linear and can be described by the quadratic equation:

$$V_{OUT} = -0.0000022 \times T^2 - 0.01105 \times T + 1.8455V$$

In many cases, a linear approximation can be applied:

$$V_{OUT} = -0.01123 \times T + 1.8455V$$

where T is the die temperature of the MAX6613 in °C.

Therefore:

 $T = (V_{OUT} - 1.8455) / 0.01123V$

Compatibility with Other Temperature Sensors

The MAX6613 can be used to replace temperature sensors using other output algorithms. Table 1 provides information for a linear and quadratic output equation. Contact the factory for performance information about another equation.

Applications Information

Sensing Circuit Board and Ambient Temperature

A temperature sensor IC like the MAX6613 that senses its own die temperature must be mounted on, or close to, the object whose temperature it is intended to measure. Because there is a good thermal path between the package's metal lead and the IC die, the MAX6613 can accurately measure the temperature of the circuit board to which it is soldered. If the sensor is intended to measure the temperature of a heat-generating component on the circuit board, it should be mounted as close as possible to that component and should share supply and ground traces (if they are not noisy) with that component where possible. This optimizes the thermal connection from the component to the sensor.

The thermal path between the plastic package and the die is not as good as the path through the lead, so the MAX6613, like all temperature sensors in plastic packages, is less sensitive to the temperature of the surrounding air than to the temperature of its leads. It can be successfully used to sense ambient temperature if the circuit board is designed to track the ambient temperature.

As with any IC, the wiring and circuits must be kept insulated and dry to avoid leakage and corrosion, especially if the part is operated at cold temperatures where condensation can occur.

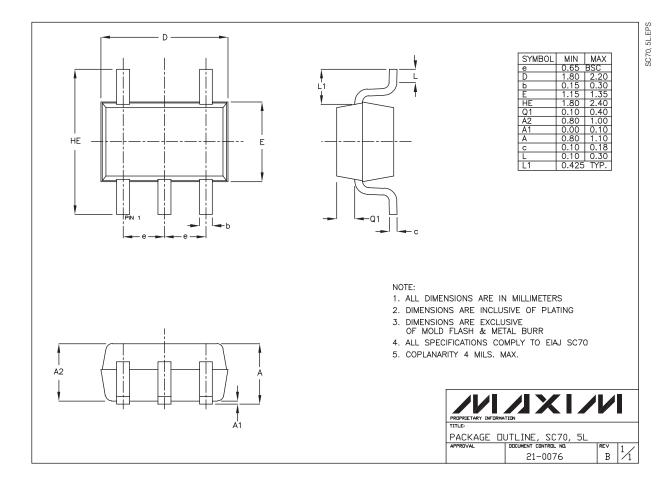
The change in die temperature introduced by the part due to self-heating is negligible.

Chip Information

TRANSISTOR COUNT: 307
PROCESS: BICMOS

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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